

CDM10V

Flexible 0-10V Dimming Solution

Features

- Simplest 0-10 V design on the market. CDM10V comes with default settings:
 - 5% minimum duty cycle
 - 1kHz PWM frequency
 - 200µA Dimmer/Resistor Bias current
 - Dim-To-Off disabled
- The simple one time programmable option allows setting in a wide range:
 - Minimum duty cycle: 1%, 2%, 5%, 10%
 - PWM output frequency: 200Hz, 500Hz, 1kHz, 2kHz
 - Dimmer/Resistor Bias Current: 50µA, 100µA, 200µA, 500µA
 - Dim-to-Off: disabled/enabled
- Wide input V_{CC} range from 11 to 25 V
- Transparent PWM mode (PWM Bypass Mode in DIM-TO-OFF enabled mode)
- Replaces many external components with a single chip reducing BOM and PCB space
- Minimum variation from device to device

Applications

- LED Drivers needing 0-10 V Dimming Circuits
- Industrial and Commercial Dimmable Applications:
 - Luminaires, Troffers, Downlights, Sconces, Undercabinet, Office Lighting, Signage applications, Dali applications

Product Type	Package
CDM10V	SOT23-6

Description

CDM10V is a fully integrated 0-10 V dimming interface IC and comes in a SOT-23-6 package to cover space requirements on small PCBs.

The device is targeted for various dimming applications in lighting. The IC can be used to transmit analog voltage based signals from a 0-10 V dimmer or potentiometer to the dimming or PWM input of a lighting controller IC in the form of a 5 mA current based PWM signal to drive an external opto-coupler. It replaces many components in a traditional solution and reduces BOM and PCB space significantly.

The CDM10V IC outputs a 0 - 100% PWM current signal at programmable frequency with an amplitude value of 5 mA.

The duty cycle of the PWM signal can be limited to a dedicated minimum value. Dim-to-off feature is supported as well and can be enabled on demand.

Embedded digital signal processing maintains minimum variations from device to device.

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1 Block Diagram



2 Pin Configuration

Pin	Name	Function
1	V _{CC}	Input voltage 11V - 25V
2	GND	GND
3	I _{out}	PWM output current 5mA
4	RxD	RxD for eFuse programming, connect to GND for normal operation
5	V _{FSS}	Fusing voltage (4,1V) eFuse programming, connect to GND for normal operation (internal pull-down)
6	R _{dim+}	Dimmer current output /Voltage sense

Functional Description

3 Functional Description

Typical Application Circuit

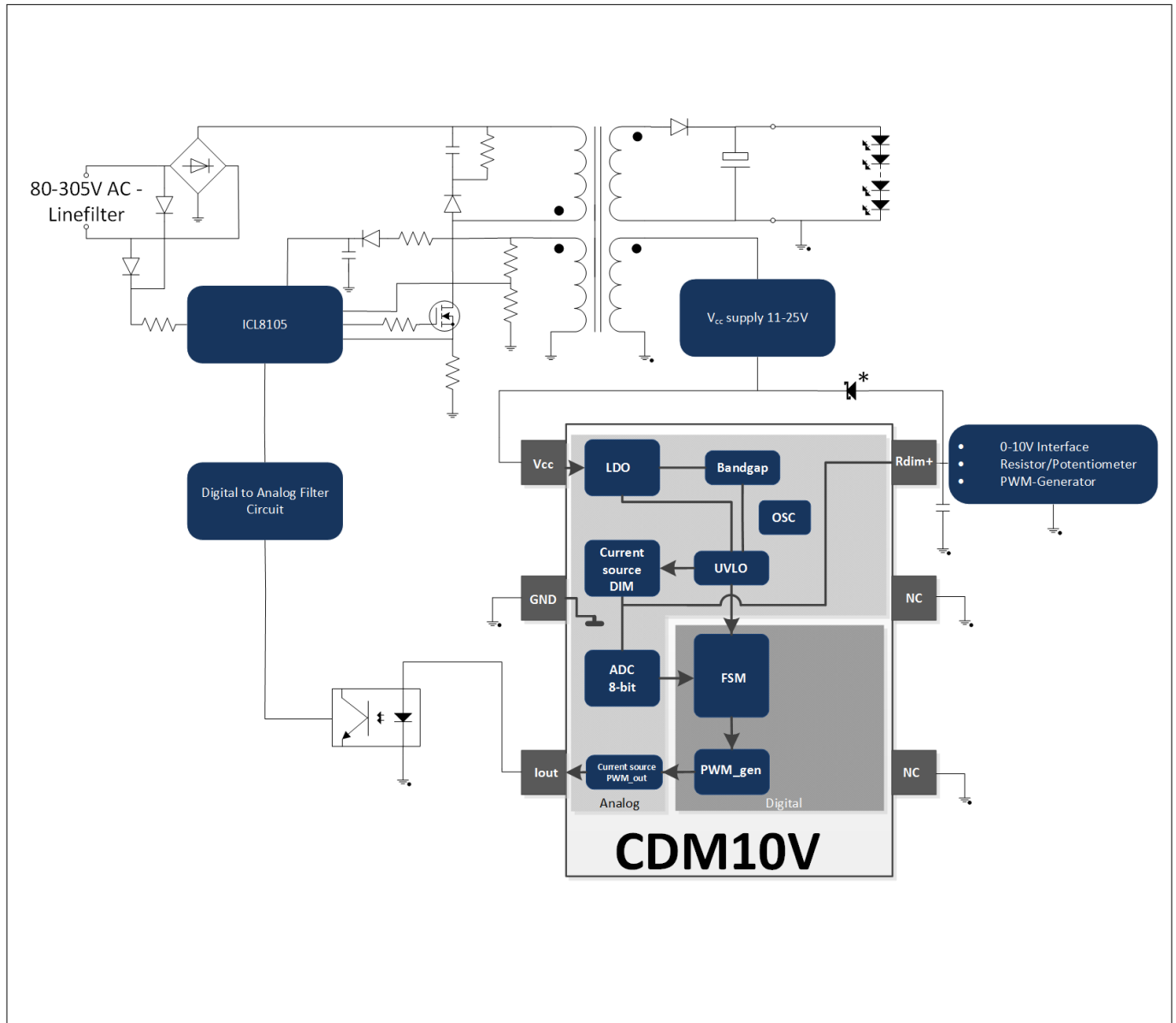


Figure 2 Typical Application Circuit

Note: The Diode marked with * is for the protection of the R_{dim+} -Pin when active dimming is used. This is because the voltage on this Pin is not allowed to be higher than $V_{CC}+0.5V$. It is advised to use a low leakage, low reverse current Schottky-Diode in order to not influence the dimming performance (e.g. MMSD301T1G).

Note: The capacitor connected to the R_{dim+} -Pin reduces the amount of coupled noise to the dimming signal. The size of this capacitance should be in the range of 2.2 - 10 nF (typ. 4.7 nF), where a small capacitor allows steeper edges of the dimming signal, a larger capacitor enhances the noise reduction.

Functional Description

Recommended cooling area

In order to guarantee the full functionality of the CDM10V device, the required cooling area has to be selected according to the graph in [Figure 3](#).

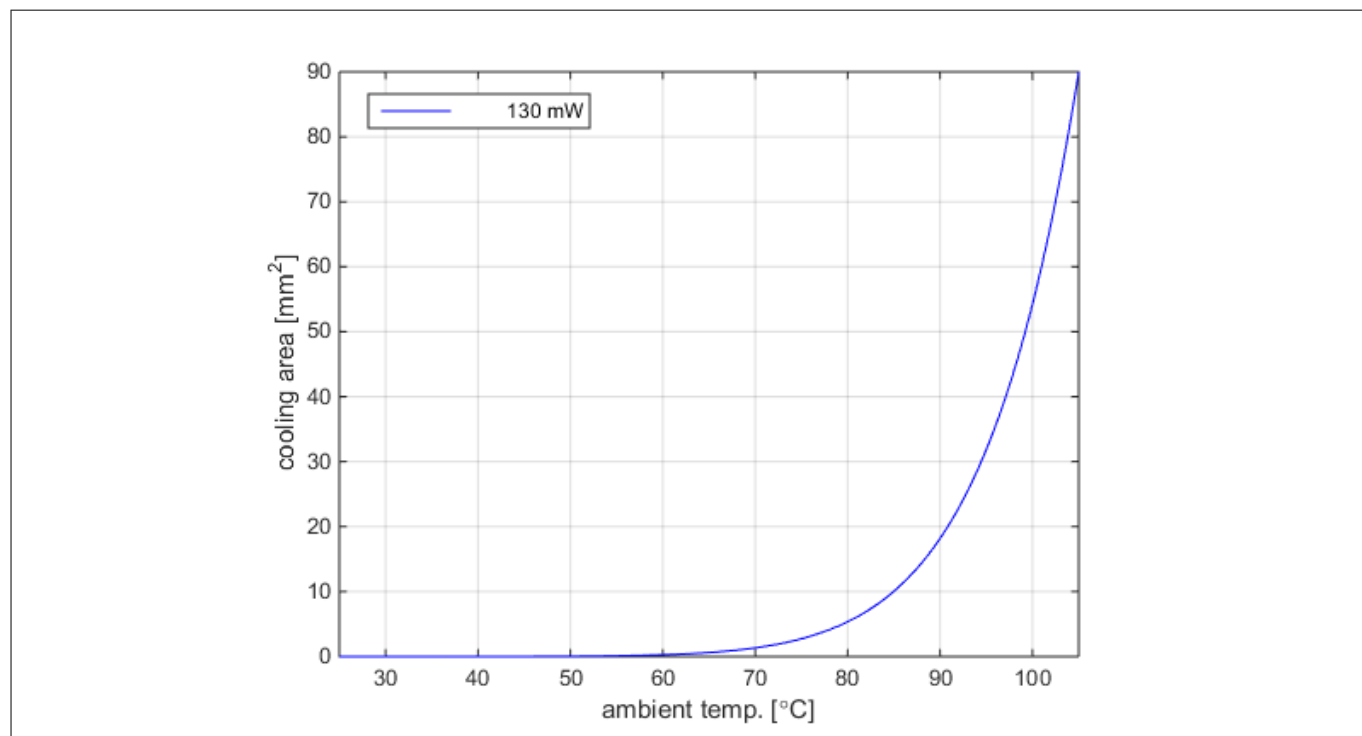


Figure 3 Cooling area over ambient temperature CDM10V

Functional Description

Dimming Characteristic

Table 2 PWM Output current referring to R_{dim+} -Pin Voltage

R_{dim+}	I_{out}
<1 V	PWM @ min duty cycle or Dim-to-OFF
1 - 9 V	min duty cycle (@ 1V)...100% (@ 9V)
>9V (max. applicable Voltage: V_{CC})	Always active

Calculation of the lower dimming voltage boundary for entering min duty cycle:

$$1\text{ V} + \text{min Duty Cycle} \times 8\text{ V}$$

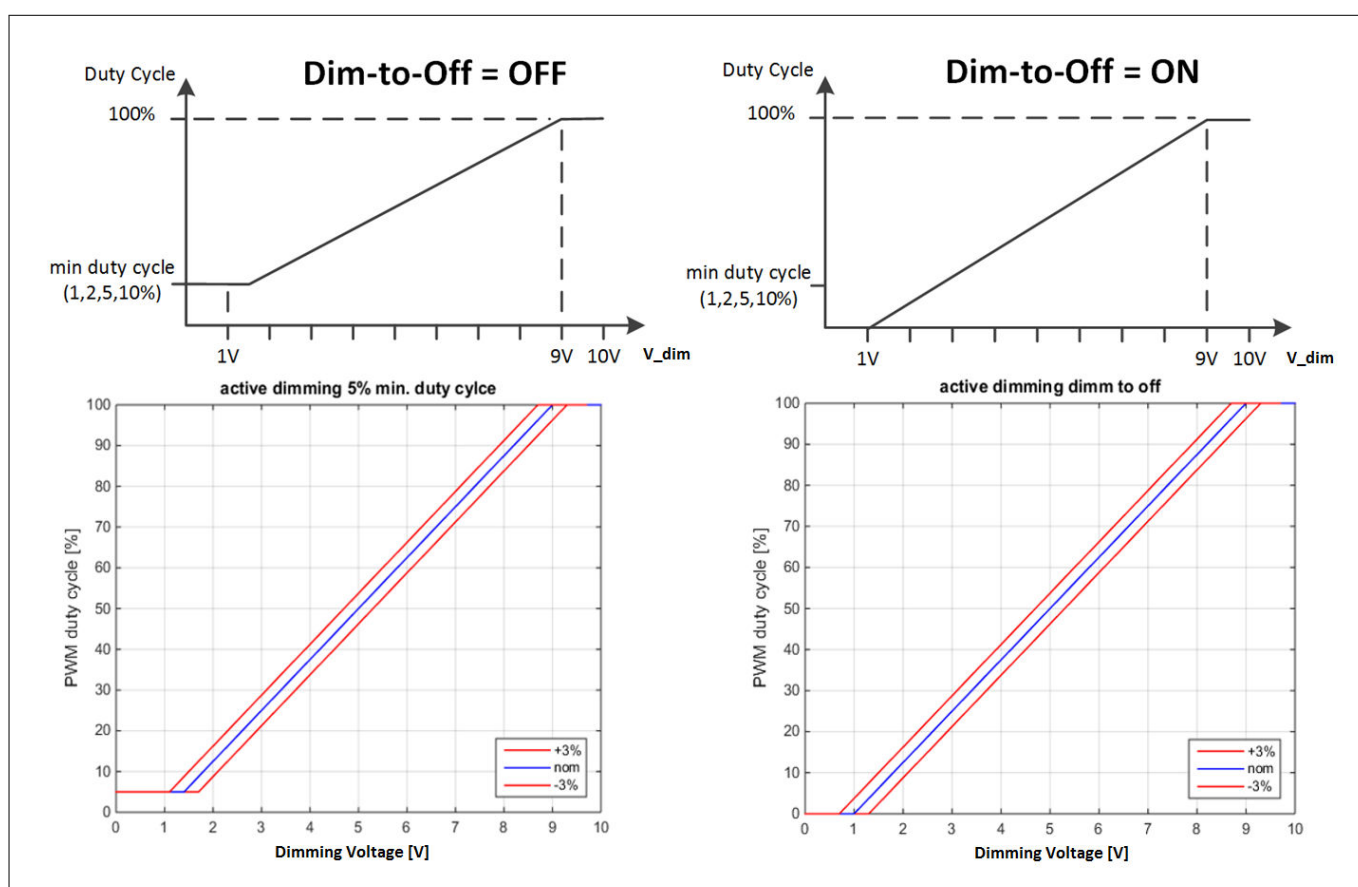


Figure 4 Dimming Characteristic

Functional Description

Transparent Mode

CDM10V device can be configured for usage in transparent mode. In this mode the PWM signal on R_{dim+} input will be provided directly to I_{out} .

Pre-condition to enable the transparent mode is to fuse the DIM2OFF bit to HIGH and PWM frequency to 2 kHz, PWM minimum duty cycle is not used in this mode and can stay in default configuration.

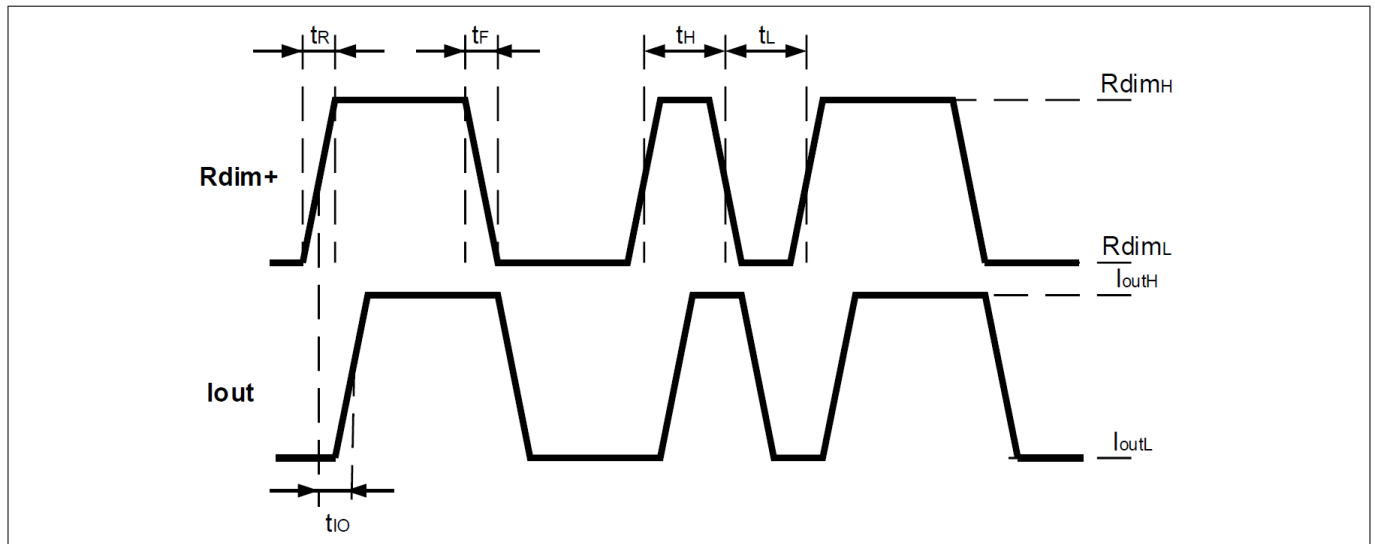


Figure 5 Transparent mode timing diagram

Table 3 Conditions for the transparent mode

Condition	Name	Min	Nom	Max
R_{dimH}	R_{dim+} High Value	9.3 V		$V_{CC}+0.5V$
R_{dimL}	R_{dim+} Low Value	-0.5 V		0.5 V
I_{outH}	I_{out} High Value		$R_{Iout} * 5mA^1$	
I_{outL}	I_{out} Low Value		0.0 V	
t_{IO}	Propagation delay		8.8 μs	
t_H	Min puls width High	2.6 μs		
t_L	Min puls width Low	2.6 μs		
t_R	Rising edge time			1.8 μs
t_F	Falling edge time			1.8 μs

Note: ¹ R_{Iout} is the resistance connected between the I_{out} and the GND-PIN

Image shows the maximum I_{out} resolution versus the R_{dim+} frequency. The dependency can be calculated using following formula:

$$f_{Rdim} = \frac{I_{out} \text{ resolution}}{100 \times 2.6 \mu s}$$

For 1% resolution we get:

$$f_{Rdim} = \frac{1}{100 \times 2.6 \mu s} \approx 3.85 \text{ kHz}$$

Functional Description

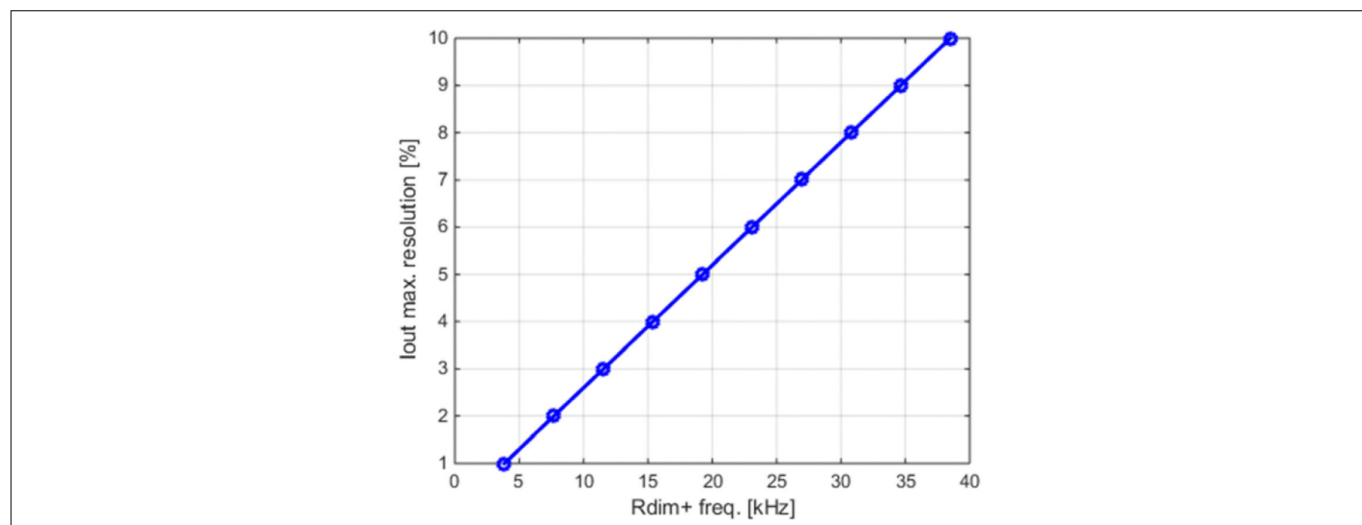


Figure 6 I_{out} resolution versus the R_{dim+} frequency

Functional Description

Optocoupler Selection Guide

CDM10V converts an analog dimming signal into a PWM waveform. In the majority of applications the dimming signal needs to be isolated from the rest of the application and an optocoupler is used to implement either functional or reinforced isolation. Optocouplers are an excellent choice since they are very cost effective but nevertheless able to comply with virtually all safety standards.

The most common and cost effective optocouplers are four-pin devices consisting of a LED and a photo-sensitive BJT. With four pin devices only collector and emitter of the BJT are connected to pins. This limits device performance, especially switching times, as will be discussed later. Six-pin devices having the base of the BJT as well connected to a pin are seen less often. With these six-pin devices bandwidth of the transmission can be improved if necessary. Finally there are high-speed digital couplers available that are designed for very high data rates and offer a buffered output with a nearly perfect PWM signal. While offering superior performance high speed couplers are considerably more expensive than simple LED-BJT couplers.

Generating an Analog Signal from PWM

Although the PWM signal itself can be used, either by implementing PWM dimming or using a dedicated SMPS controller that is able to extract the dimming information directly from the PWM waveform, in many applications a DC voltage that is proportional to the desired dimming level is needed. Fortunately it is easy to create an analog signal from PWM: a low pass filter with the right corner frequency will do the job.

As a rule of thumb a corner frequency of $f_{PWM}/100$ for a first order filter and $f_{PWM}/10$ for second order filter should be used. With this selection ripple on the generated DC signal is around 150 mV_{pp} at medium dimming levels and goes down to a few 10 mV_{pp} at very low and high dimming levels. The first order filter will have a slower time response due to the low corner frequency. Consequently, if for some reason a f_{PWM} lower than 1 kHz has to be used, as second order filter will give the better response. With a third order filter it is possible to achieve either negligible ripple on the DC voltage or superior response time.

Since the generated DC voltage not only depends on the duty-cycle of the PWM signal but is directly proportional to its amplitude as well it is mandatory to stabilize the amplitude e.g. with a Zener-Diode.

Image shows a simplified schematic with second order filter. According to the design guideline given above, good starting values for C_1 and C_2 would be:

$$C_1 = C_2 = 150 \text{ nF} \times \frac{1 \text{ kHz}}{f_{PWM}}$$

Note: Using the ICL8105 the capacitor connected to the UART/Dim-Pin is not allowed to exceed 1nF in order to provide proper UART communication if needed.

Inverted / Non-Inverted Output

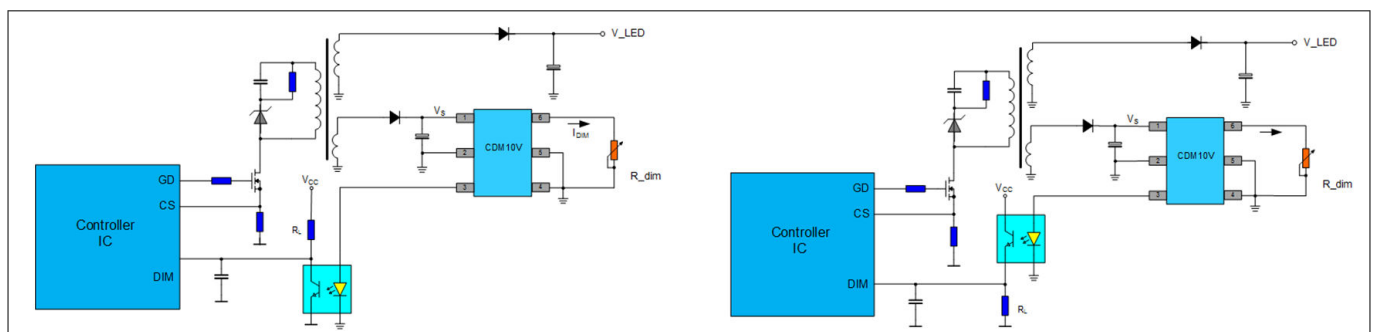


Figure 7 Simplified schematic of CDM10V with inverted (left) and non-inverted (right) output signal. Both are equivalent in terms of performance

Optocouplers are most often used in the configuration shown on the left of **Image** i.e. the output signal is derived from the collector of the BJT and thus inverted compared to the input signal. An inverted signal is not favorable at all since it will result in an inverted dimming characteristic with the majority of controllers. An additional inverter stage could be used of course, resulting in the proper dimming curve. But there is a simpler

Functional Description

solution as well since the four pin optocoupler can be viewed as current controlled current source if V_{CE} of the BJT is sufficiently high. Consequently the load can be connected either to collector or emitter without significant change in parameters or performance. Therefore the configuration on the right of *Image* is favorable for most SMPS controllers.

Optocoupler selection

There are two parameters of an optocoupler that are most important for use with CDM10V: the current transfer ratio CTR and the switching times T_r and T_f .

Image is a typical plot of T_r and T_f vs. R_L taken from the data sheet of a widely used 4-pin optocoupler. Both parameters depend on the load resistance R_L . But while T_r doesn't vary too much and shows a moderate maximum for R_L of few hundred ohms, T_f is constantly increasing with R_L , reaching about 100 μ s for R_L around 10 k Ω . These times are much longer than the minimum pulse length generated by CDM10V shown in table *Table 4*. Consequently relative low values for R_L around 100 Ω seem to be necessary in order to achieve reasonable switching times. But it's important to mention, that switching times shown in *Image* are determined with saturated BJT (this means the load resistance limits the IC to a lower value than would be determined by LED current) and with non-saturated BJT switching times can be small, even with higher load resistance.

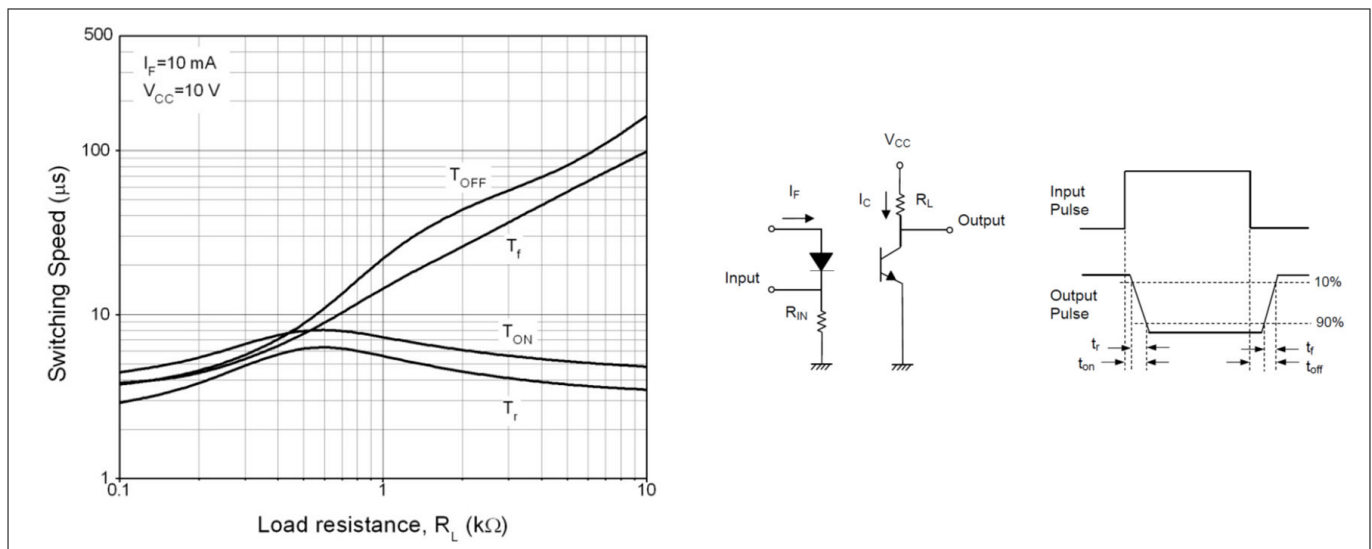


Figure 8 Typical optocoupler switching times vs. load resistance together with test circuit.

Before discussing influence of load resistance on switching performance further, the second important parameter of the coupler, CTR, needs investigation.

Table 4 Shortest pulse length for different frequencies and minimum dimming levels of CDM10V

Frequency	Dim-to-off	1%	2%	5%	10%
200 Hz	1.2 μ s	50 μ s	100 μ s	250 μ s	500 μ s
500 Hz	7.84 μ s	20 μ s	40 μ s	100 μ s	200 μ s
1 kHz	3.92 μ s	10 μ s	20 μ s	50 μ s	100 μ s
2 kHz	1.96 μ s	5 μ s	10 μ s	25 μ s	50 μ s

As the name implies, CTR is simply the ratio between the forward current I_F of the LED and the resulting collector current I_C of the phototransistor and usually expressed in percent. A CTR of 50% for example means that the collector current is 50% or half of the LED current. CTR is of course not constant but depends on the LED current as well as on temperature. For many optocouplers CTR is specified for a nominal current of 5mA but can have considerably higher CTR at higher currents while being much lower at currents below 5 mA. Since CDM10V drives a constant current of 5 mA it fits very well to the most common couplers on the market. For a given coupler the CTR shows wide variation from device to device, varying for example from 50% to 600% for a

Functional Description

widely used coupler. Therefore selections are available with a CTR variation of 1:2 ranging e.g. from 100% to 200%.

As said before, the 4-pin coupler with phototransistor can be seen as a current-controlled current source and CDM10V is driving a current of 5 mA, resulting in a collector current (= emitter current) ranging from 2.5 mA to 30 mA for a non-selected coupler. With a 100 Ω load resistor the output signal thus would vary from 250 mV to 3V. This leads to the conclusion that small load resistance is desirable for good switching behavior but leads to small output signal and this signal varies too much with CTR instead of having a constant amplitude as requested initially. A solution for achieving constant amplitude could be to make the load resistance big enough that the transistor would go into saturation. The voltage drop across a BJT in saturation is small and doesn't vary much with temperature but switching speed is very poor in this condition.

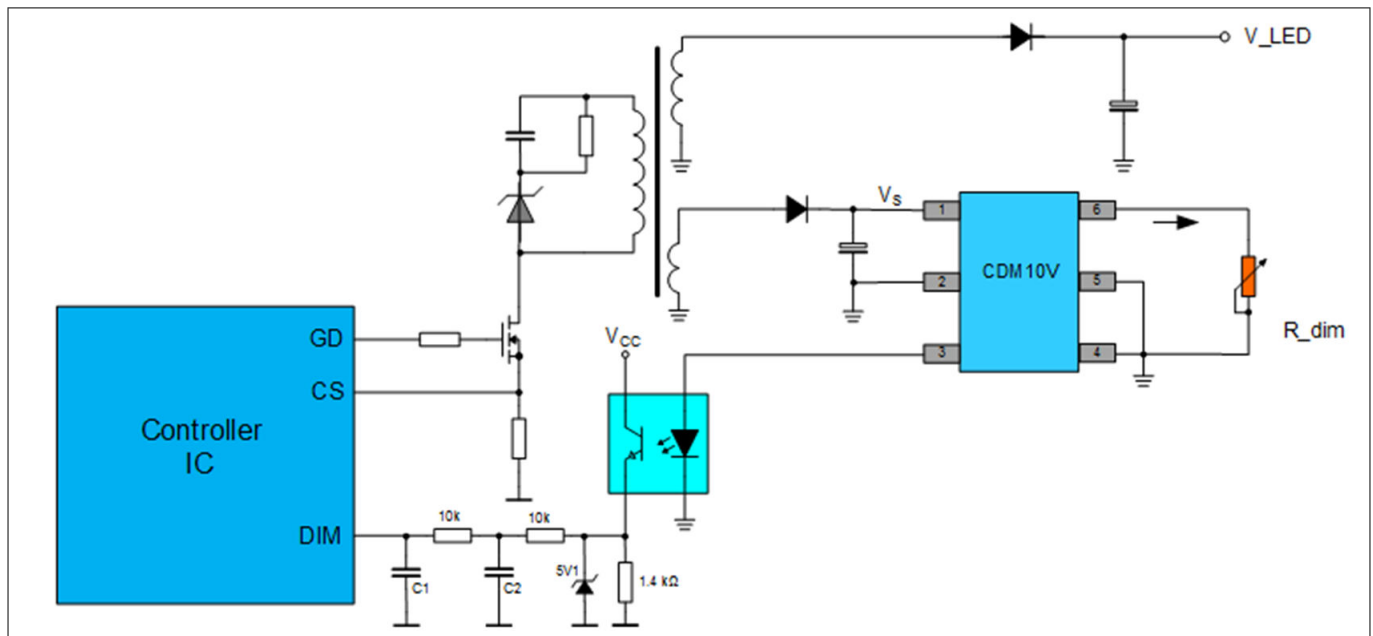


Figure 9 Simplified schematic showing second order filter and best configuration of coupler

All of the above put together results in a set of simple rules of optocoupler selection:

1. Use the lowest PWM frequency that gives reasonable dimming response.
Example: With $f_{PWM} = 1\text{ kHz}$ a second order filter with a corner frequency of 100 Hz should be used. The response time of this filter to a step from 10% to 90% dimming level is about 10 ms and after 20 ms the final level is reached.
2. Use an optocoupler with a selected CTR range like e.g. 100% to 200%.
3. Use a load resistance that allows the desired output voltage even with lowest CTR over all possible operating conditions.

Example:

$$CTR_{min} = 80\%, V_{Out} = 5\text{ V}, I_{LED, max} = 4.5\text{ mA}$$

$$R_L = \frac{V_{out}}{CTR_{min} \times I_{LED, min}} = \frac{5\text{ V}}{0.8 \times 4.5\text{ mA}} = 1.388\text{ k}\Omega$$

4. To prevent saturated switching, use a supply voltage V_{CC} that is at least 2V higher than the desired output voltage V_{Out} . V_{CC} shouldn't be too high on the other hand to limit power losses.

Example:

$$V_{CC} = 15\text{ V}, CTR_{max} = 200\%, I_{LED, max} = 5.45\text{ mA}, \text{Dimm-Level } 100\%$$

$$P_{Loss, max} = 2.2 \times 5.45\text{ mA} \times 15\text{ V} = 179.85\text{ mW}$$

Obviously with a V_{CC} of 7.5 V these losses would be halved to about 90 mW. It's important to keep in mind, that this is the maximum loss that only occurs at maximum light output. At minimum dimming level or dim-to-off the loss added by the optocoupler circuit will be negligible.

Functional Description

5. Use a Zener diode to limit and stabilize the output voltage to the desired value. In the above example a 5.1 V Zener with 2% accuracy should be used.

A circuit that complies with all the above is shown in [Image](#). An optocoupler device that complies with the above mentioned rules and has actually been tested in the application is VO617A-2 by Vishay Semiconductor. There are of course many devices available that have very similar, if not identical, technical data regarding switching times vs. load resistance and CTR selection. As an example devices as FOD817A, HCPL-817-xxAE or LTV-817A, EL817A or TLP183 GRL, to name only a few, can be used in this application. Nevertheless the desired performance has to be verified in the application in each single case.

Electrical Characteristics and Parameters

4 Electrical Characteristics and Parameters

Table 5 Absolute Maximum Ratings

Pin	Name	Values		Unit	Note or Test Condition
		Min.	Max.		
1	V _{CC}	11	25	V	
2	GND	0	0	V	Point of reference
3	I _{out}	-0.5	3.63	V	Depending on the optocoupler voltage @ 5mA
4	RxD	-0.25	0.1	V	Connect to GND during operation
5	V _{FSS}	-0.25	0.1	V	During operation Connect to GND
6	R _{dim+}	-0.5	V _{CC} + 0.5	V	An applied voltage above max value leads to the destruction of the device. Also valid if V _{CC} is 0 V.

Absolute maximum ratings ([Table 5](#)) are defined as ratings which when being exceeded may lead to destruction of the integrated circuit. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. These values are not tested during production test.

Table 6 Electrical Characteristics

Parameter	Programmable	Symbol	Values			Unit	Note or Test Condition
			Min.	Typ.	Max.		
Input Voltage		V _{in}	11		25	V	Operating Voltage
Junction Temperature Range		T _J	-40		135	°C	
Ambient Temperature Range		T _A	-40		105	°C	
Power Dissipation		P _{tot}	6.05 @ 1% duty cycle; 6.6 @ 2% duty cycle; 8.25 @ 5% duty cycle; 11 @ 10% duty cycle	130 @ 100% duty cycle 83.2 @ 70% duty cycle 54 @ 50% duty cycle 30.4 @ 30% duty cycle	160 @ 100% PWM & 25 V _{in}	mW	Dimmer current included
Current Consumption		I _{CC}			1	mA	Current Consumption of the IC for self supply

Electrical Characteristics and Parameters

Table 6 Electrical Characteristics (continued)

Parameter	Programmable	Symbol	Values			Unit	Note or Test Condition
			Min.	Typ.	Max.		
Output Current for Dimmer	yes	I_{dim}	-10%	50/100/ <u>200</u> /500	+10%	μA	Current flow out of $R_{\text{dim}+}$ Pin
Output Current for Optocoupler		I_{out}	-10%	5	+10%	mA	
PWM frequency	yes	f_{PWM}	-6%	200/500/ <u>1000</u> /2000	+6%	Hz	
Min. duty cycle	yes	PW_{PWM}	-0.2	1/2/ <u>5</u> /10	+0.2	%	Percentage of the pulse width
Dimming accuracy			-3		+3	%	With active dimming incl. all variations
Fusing Voltage		V_{FSS}	4.0	4.1	4.2	V	For eFuse programming, connect to GND for normal operation
Wake-up Time		t_w			40	μs	Time from $V_{\text{CC}} = 11\text{ V}$ to first output current
ESD capability HBM		V_{HAB}			1500	V	according to ANSI/ESDA/JEDEC JS-001
ESD capability CDM		V_{CDM}			500		according to JESD22 C101

5 Chip Configuration

Typical eFuse programming Circuit

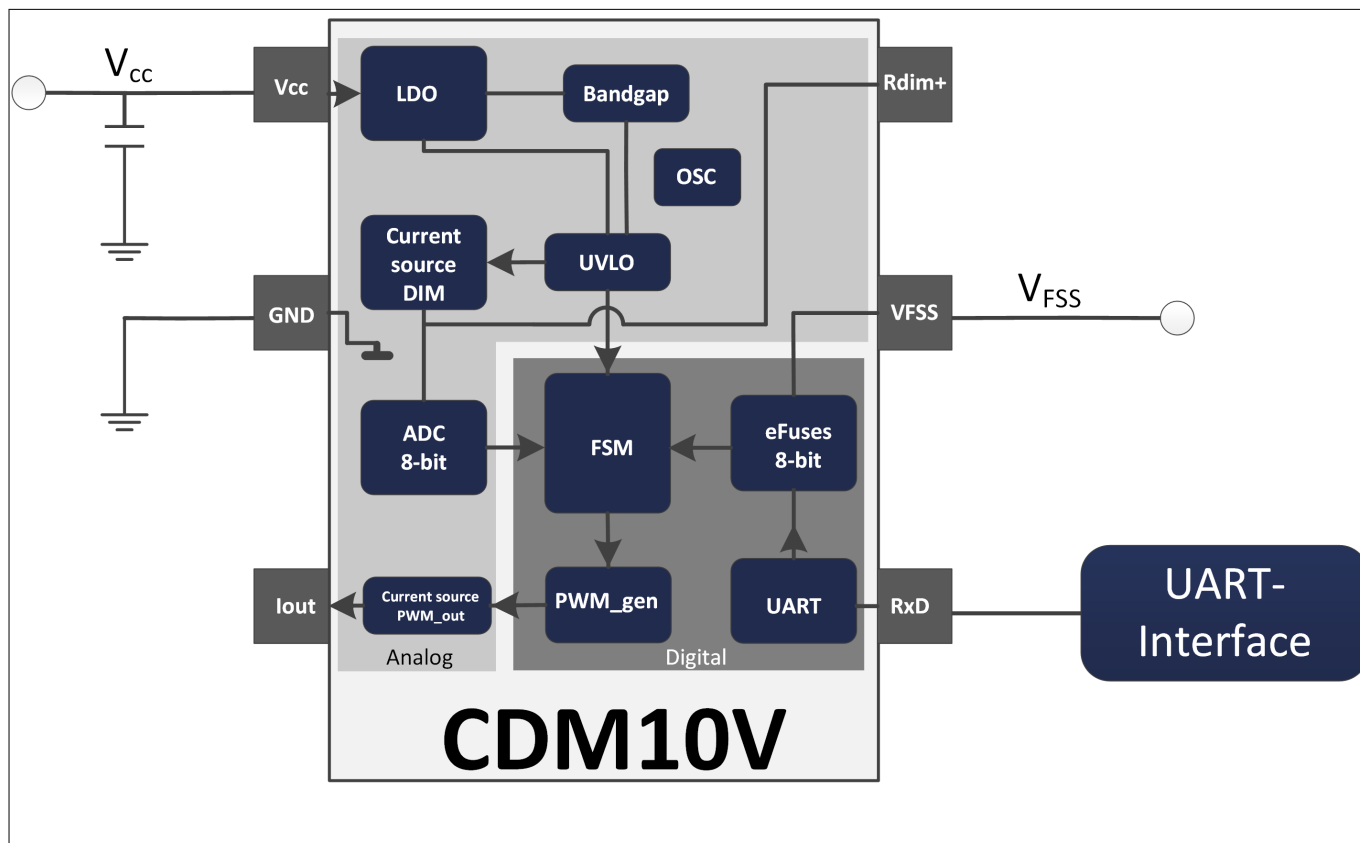


Figure 10 Typical eFuse programming Circuit

Serial Port

The serial port enables a one time reconfiguration of parameters for device function.

Characteristics of the communication:

Baudrate: 9600Bd; one stop bit; no parity bit

Timing diagram:

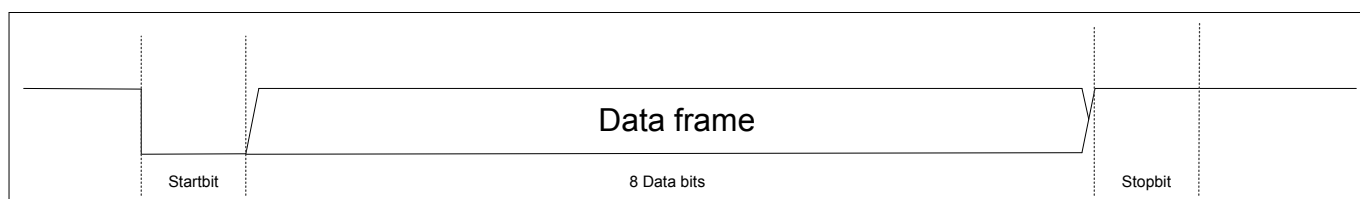


Figure 11 Timing diagram for the serial communication

Chip Configuration

Data frame format:

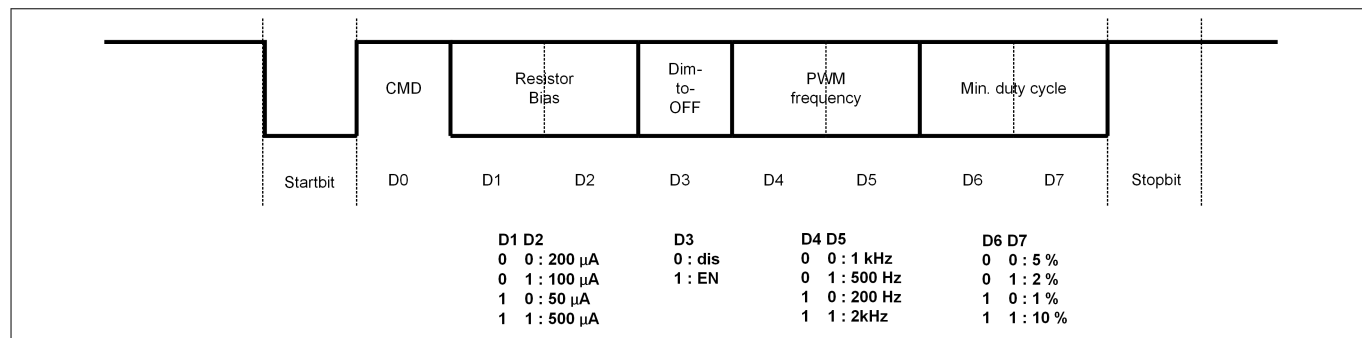


Figure 12 Data frame format for the Serial Communication

Table 7 Bit setting for the one time reconfiguration

Bit group	Value	Meaning	Comment
CMD	1	Always high	reserved
Dimmer/Resistor Bias	00	200 μA	Default
	01	100 μ A	
	10	50 μ A	
	11	500 μ A	
Dim-to-Off	0	NOT ENABLED	Default
	1	Enable	
PWM Frequency	00	1 kHz	Default
	01	500 Hz	
	10	200 Hz	
	11	2 kHz	
Minimum duty cycle	00	5 %	Default
	01	2 %	
	10	1 %	
	11	10 %	

Package Dimensions

6 Package Dimensions

All dimensions in mm.

Package Drawings

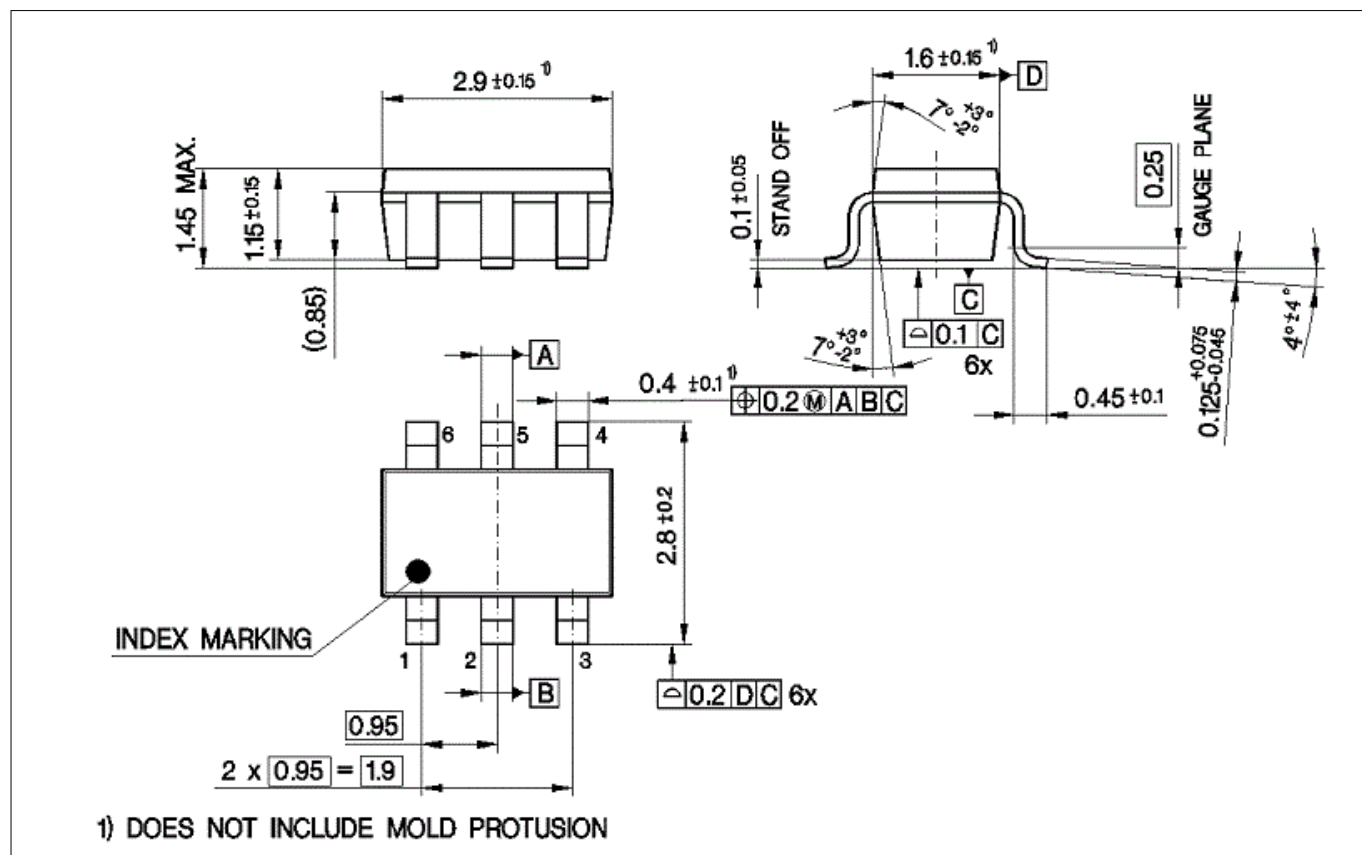


Figure 13 Package Drawings

Package Dimensions

Footprint

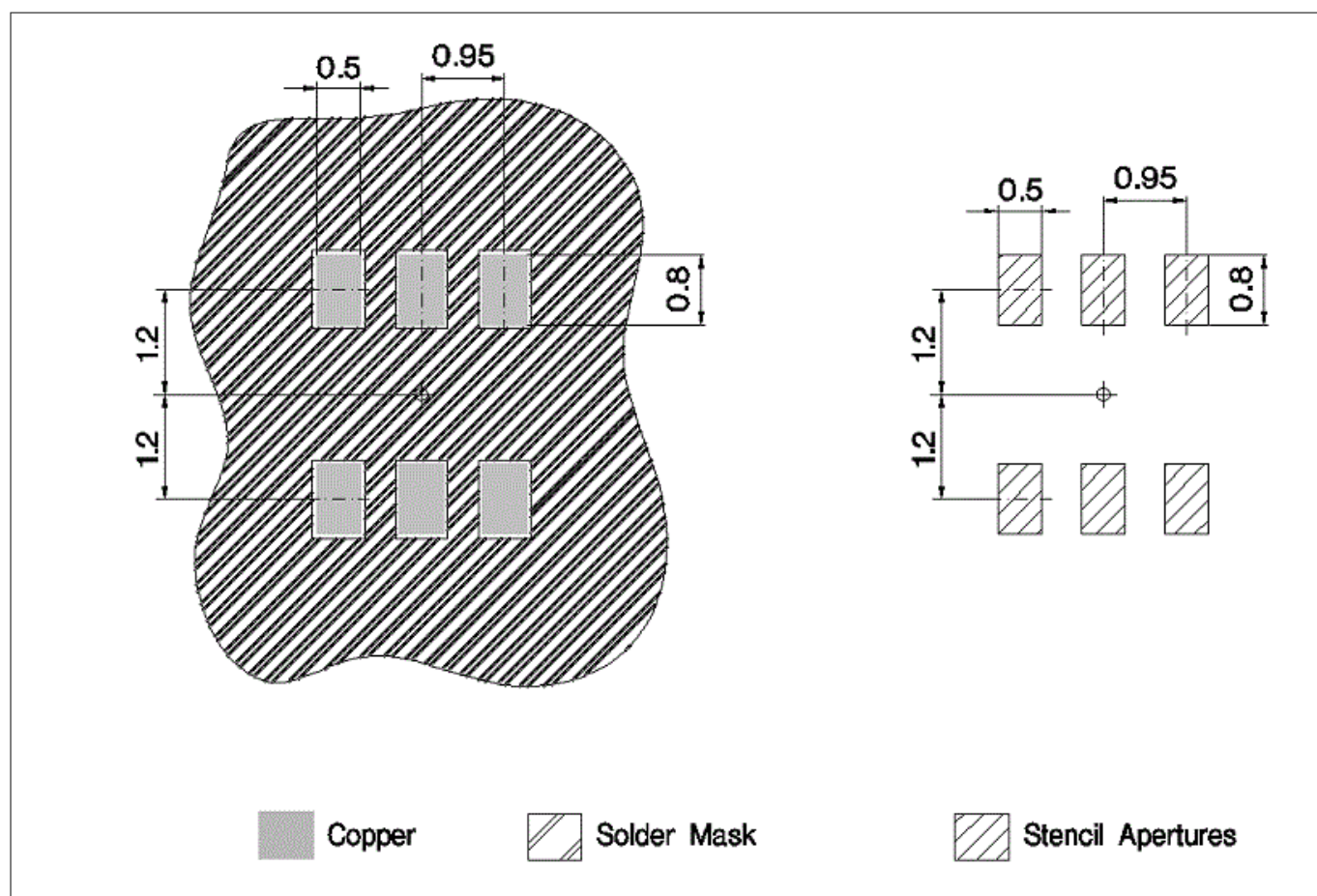


Figure 14 Footprint

References

Packing Description

Packing Type

Tape and Reel
 Ø Reel: 180
 Pieces / Reel: 3000
 Reels / Box: 1

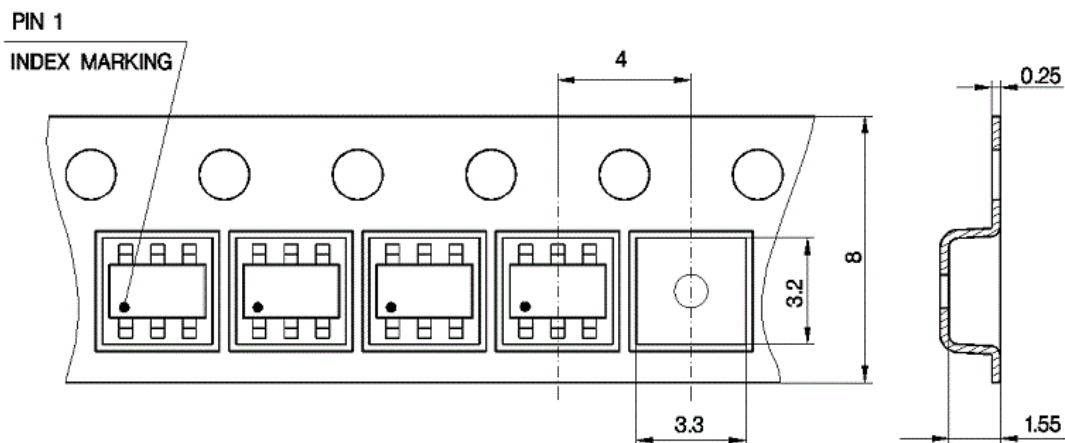


Figure 15 Packing

7 References

Additional support material can be found under the following link.

Related information

<http://www.infineon.com/CDM10V>

Revision History

Major changes since previous revision

Revision History

Reference	Description
v1.0	Initial Version
v1.1	Typos, added Table 5
v1.2	Typos p 12, p 13
v1.3	Additional information about the max rating of Rdim-Pin (Image , Table 5)

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